



## Wireless Stick Lite LoRa Node Development Kit



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## Document version

Version	Time	Description
V1.0	2017-06-01	Documents creating
V2.0	2020-09-24	Document structure update

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# 1. Description

## 1.1 Overview

Many users need a version without OLED display, because they want to use it directly in their IoT projects as the main controller and RF (LoRa, Wi-Fi, BLE) connection.

Compare with [Wireless Stick](#), “Wireless Stick Lite” has much better low power design (30uA in deep sleep). Removed the 0.49” OLED, use [ESP32-PICO](#) MCU (it’s more friendly for low power design).

Wireless Stick Lite are available in two product variants:

Table 1.1 Product model list

No.	Model	Description
1	Wireless Stick Lite-L	470~510MHz working LoRa frequency, used for China mainland (CN470) LPW band.
2	Wireless Stick Lite-F	For EU868, IN865, US915, AU915, AS923, KR920 and other LPW networks with operating frequencies between 863~928MHz.

## 1.2 Product features

- CE Certificate;
- Microprocessor: [ESP32-PICO](#) (dual-core 32-bit MCU + ULP core + Internal 4MB FLASH), with LoRa node chip SX1276;
- Micro USB interface with a complete voltage regulator, ESD protection, short

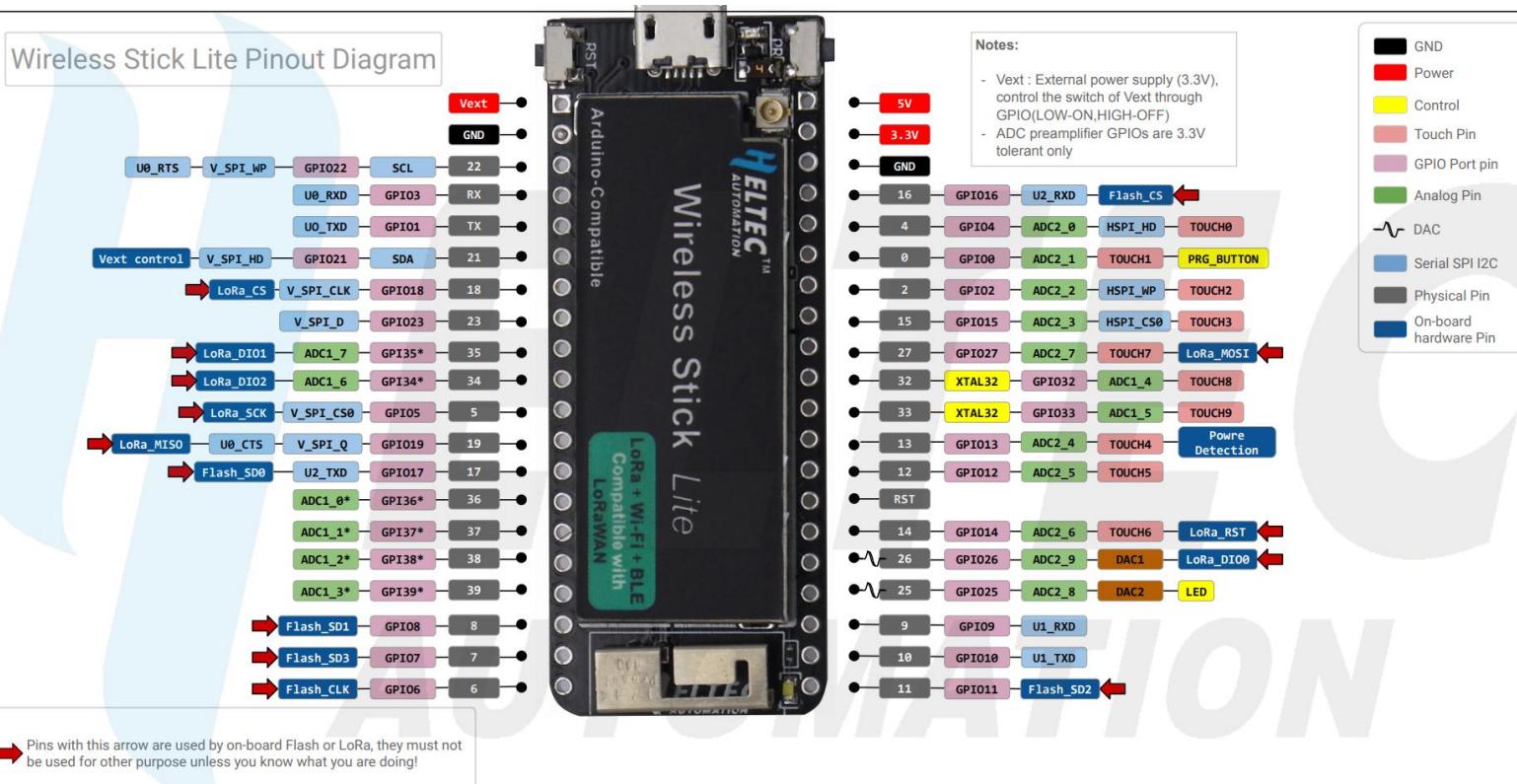
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circuit protection, RF shielding, and other protection measures;

- Onboard SH1.25-2 battery interface, integrated lithium battery management system (charge and discharge management, overcharge protection, battery power detection, USB / battery power automatic switching);
- Integrated WiFi, LoRa, Bluetooth three network connections, onboard Wi-Fi, Bluetooth dedicated 2.4GHz metal 3D antenna, reserved IPEX (U.FL) interface for LoRa;
- Integrated CP2102 USB to serial port chip, convenient for program downloading, debugging information printing;
- Support the [Arduino development environment](#);
- (Exclusive) Supports the Arduino version of the [ESP32 + LoRaWAN](#) protocol routine provided by Heltec. This is a standard LoRaWAN protocol that can communicate with any gateway/base station running the LoRaWAN protocol (requires serial number activation, only the development of the company) The board is available, the serial number can be queried on [this page](#));
- With good RF circuit design and good low-power design (sleep current  $\leq$  30uA), it is convenient for IoT application vendors to quickly verify solutions and deploy applications.

## 2. Pin Definition

### 2.1 Pin assignment



### 2.2 Pin description

- Header J2

Table 2-2-1 Pin description

No.	Name	Type	Function
1	GND	P	Ground.
2	5V	P	5V Power Supply.
3	Ve	P	Output 3.3V, power supply for external sensor.
4	Ve	P	Output 3.3V, power supply for external sensor.
5	RX	I/O	GPIO44, U0RXD, connected to CP2102 TXD.
6	TX	I/O	GPIO43, U0RXD, connected to CP2102 RXD.
7	RST	I	CHIP_PU, connect to RST switch.
8	0	I/O	GPIO0, connect to PRG switch.

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<b>9</b>	36	I/O	GPIO36, SPIIO7, FSPICLK, SUBSPICLK, <b>Vext Ctrl.</b>
<b>10</b>	35	I/O	GPIO35, SPIIO6, FSPID, SUBSPID, <b>LED Write Ctrl.</b>
<b>11</b>	34	I/O	GPIO34, SPIIO5, FSPICS0, SUBSPICS0.
<b>12</b>	33	I/O	GPIO33, SPIIO4, FSPIHD, SUBSPIHD.
<b>13</b>	47	I/O	GPIO47, SPICLK_P_DIFF, SUBSPICLK_P_DIFF.
<b>14</b>	48	I/O	GPIO48, SPICLK_N_DIFF, SUBSPICLK_N_DIFF.
<b>15</b>	26	I/O	GPIO26, SPICS1.
<b>16</b>	21	I/O	GPIO21, <b>OLED RST.</b>
<b>17</b>	20	I/O	GPIO20, U1CTS, ADC2_CH9, CLK_OUT1, USB_D+ <sup>1</sup> .
<b>18</b>	19	I/O	GPIO19, U1RTS, ADC2_CH8, CLK_OUT2, USB_D- <sup>2</sup> .

### Header J3

Table 2-2-2 Pin description

No.	Name	Type	Function
<b>1</b>	GND	P	Ground.
<b>2</b>	3V3	P	3.3V Power Supply.
<b>3</b>	3V3	P	3.3V Power Supply.
<b>4</b>	37	I/O	GPIO37, SPIDQS, FSPIQ, SUBSPIQ.
<b>5</b>	46	I/O	GPIO46.
<b>6</b>	45	I/O	GPIO45.
<b>7</b>	42	I/O	GPIO42, MTMS.
<b>8</b>	41	I/O	GPIO41, MTDI.
<b>9</b>	40	I/O	GPIO40, MTDO.
<b>10</b>	39	I/O	GPIO39, MTCK.
<b>11</b>	38	I/O	GPIO38, FSPIWP, SUBSPIWP.
<b>12</b>	1	I/O	GPIO1, ADC1_CH0 <sup>3</sup> , TOUCH1, <b>Read VBAT Voltage.</b>
<b>13</b>	2	I/O	GPIO2, ADC1_CH1, TOUCH2.
<b>14</b>	3	I/O	GPIO3, ADC1_CH2, TOUCH3.

<sup>1</sup> DP pin connectable to USB socket, solder R29

<sup>2</sup> DN pin connectable to USB socket, solder R3

<sup>3</sup> ADC1\_CH0 is used to read the lithium battery voltage, the voltage of the lithium battery is:

$$\text{VBAT} = 100 / (100+390) * \text{VADC\_IN1}$$

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<b>15</b>	4	I/O	GPIO4, ADC1_CH3, TOUCH4.
<b>16</b>	5	I/O	GPIO5, ADC1_CH4, TOUCH5.
<b>17</b>	6	I/O	GPIO6, ADC1_CH5, TOUCH6.
<b>18</b>	7	I/O	GPIO7, ADC1_CH6, TOUCH7.

## 3. Specifications

### 3.1 General specifications

Table 3-1: General specifications

Parameters	Description
<b>Master Chip</b>	ESP32-PICO-D4( 240MHz Tensilica LX6 dual-core + 1 ULP, 600 DMIPS)
<b>LoRa Chipset</b>	SX1276
<b>USB to Serial Chip</b>	CP2102
<b>Frequency</b>	470~510 MHz, 863~923 MHz
<b>Max TX Power</b>	19dB ± 1dB
<b>Receiving sensitivity</b>	-135 dBm
<b>Wi-Fi</b>	802.11 b/g/n (802.11n up to 150 Mbps)
<b>Bluetooth</b>	Bluetooth V4.2 BR/EDR and Bluetooth LE specification
<b>Hardware Resource</b>	UART x 3; SPI x 2; I2C x 2; I2S x 1; 12-bits ADC input x 18; 8-bits DAC output x 2; GPIO x 28, GPI x 6
<b>Memory</b>	4MB(32M-bits) internal SPI FLASH; 520KB internal SRAM
<b>Interface</b>	Micro USB x 1; LoRa Antenna interface(IPEX) x 1; 20 x 2.54 pin x 2
<b>Battery</b>	3.7V Lithium(SH1.25 x 2 socket)

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<b>Operating temperature</b>	-20 ~ 70 °C
<b>Dimensions</b>	59.3 x 24.8 x 8 mm
<b>Low Power</b>	Deep Sleep 30 μ A

### 3.2 Power supply

Except when USB or 5V Pin is connected separately, lithium battery can be connected to charge it. In other cases, only a single power supply can be connected.

Table 3-2: Power supply

Power supply mode	Minimum	Typical	Maximum	Company
USB powered( $\geq 500\text{mA}$ )	4.7	5	6	V
Lithium battery( $\geq 250\text{mA}$ )	3.3	3.7	4.2	V
5V pin( $\geq 500\text{mA}$ )	4.7	5	6	V
3V3 pin( $\geq 150\text{mA}$ )	2.7	3.3	3.5	V

### 3.3 Power output

Table 3-3: Power output

Output Pin	Minimum	Typical	Maximum	Company
3.3V Pin			500	mA
5V Pin (USB Powered only)		Equal to the input current		
Vext Pin			350	mA

### 3.4 Power characteristics

Table 3-4: Power characteristics

Mode	Condition	Min.	Typical	Max.	Company
WiFi Scan	USB powered		115		mA
WiFi AP	USB powered		135		mA
Power Consumption(mA)	LoRa 10dB output		50		mA
	LoRa 12dB output		60		mA
	LoRa 15dB output		110		mA
	LoRa 20dB output		130		mA

### 3.5 LoRa RF characteristics

#### 3.5.1 Transmit power

Table 3-5 Transmit power

Operating frequency band	Maximum power value/[dBm]
470~510	19 ± 1
867~870	19 ± 1
902~928	19 ± 1

#### 3.5.2 Receiving sensitivity

The following table gives typically sensitivity level of the Wireless Stick Lite-(L/H).

Table 3-6: Receiving sensitivity

Signal Bandwidth/[KHz]	Spreading Factor	Sensitivity/[dBm]

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<b>125</b>	SF12	-135
<b>125</b>	SF10	-130
<b>125</b>	SF7	-124

### 3.6 Operation Frequencies

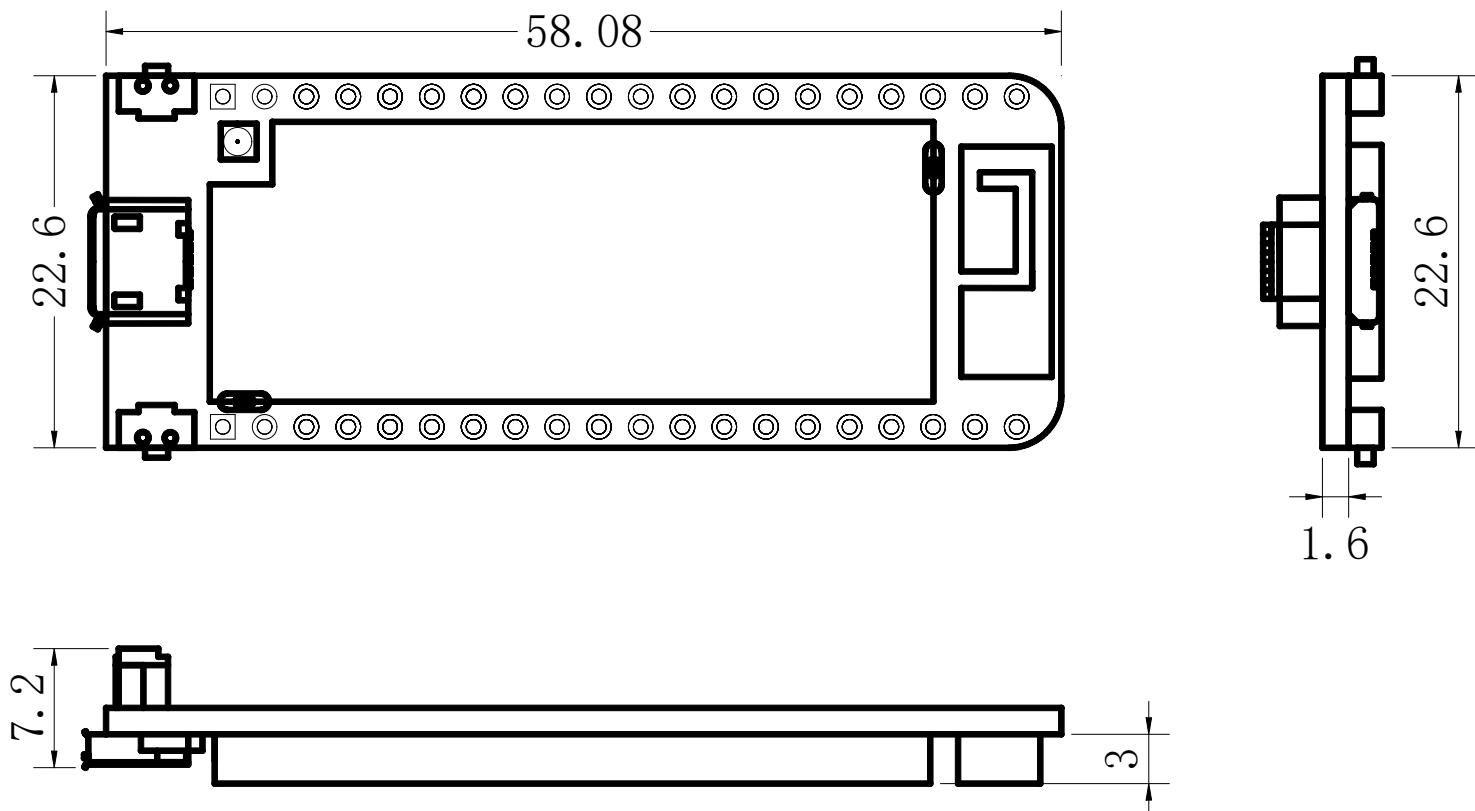
Wireless Stick Lite(F) supports LoRaWAN frequency channels and models corresponding table.

Table3-7: Operation Frequencies

Region	Frequency (MHz)	Model
<b>EU433</b>	433.175~434.665	Wireless Stick Lite-L
<b>CN470</b>	470~510	Wireless Stick Lite-L
<b>IN868</b>	865~867	Wireless Stick Lite-F
<b>EU868</b>	863~870	Wireless Stick Lite-F
<b>US915</b>	902~928	Wireless Stick Lite-F
<b>AU915</b>	915~928	Wireless Stick Lite-F
<b>KR920</b>	920~923	Wireless Stick Lite-F
<b>AS923</b>	920~925	Wireless Stick Lite-F

## 4. Hardware resource

### 4.1 Physical dimensions



## 5. Resource

### 5.1 Relevant Resource

- Source Code
  - [Heltec ESP \(ESP32 & ESP8266\) framework](#) (Already included Heltec ESP32 LoRaWAN library)
  - [Heltec ESP32 library](#)
- [Schematic diagram](#)
- [Pin map](#)
- [Downloadable resource](#)

### 5.2 Contact Information

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